



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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MCH6103/MCH6203

Bipolar Transistor

(-) $50V$, (-) $1A$, Low $V_{CE(sat)}$, (PNP)NPN Single MCPH6

ON Semiconductor®

<http://onsemi.com>

Applications

- Relay drivers, lamp drivers, motor drivers, flash

Features

- Adoption of MBIT processes
- Low collector-to-emitter saturation voltage
- Ultrasmall package facilitates miniaturization in end products (mounting height : 0.85mm)
- High allowable power dissipation
- Large current capacity
- High-speed switching

Specifications () : MCH6103

Absolute Maximum Ratings at $T_a=25^{\circ}C$

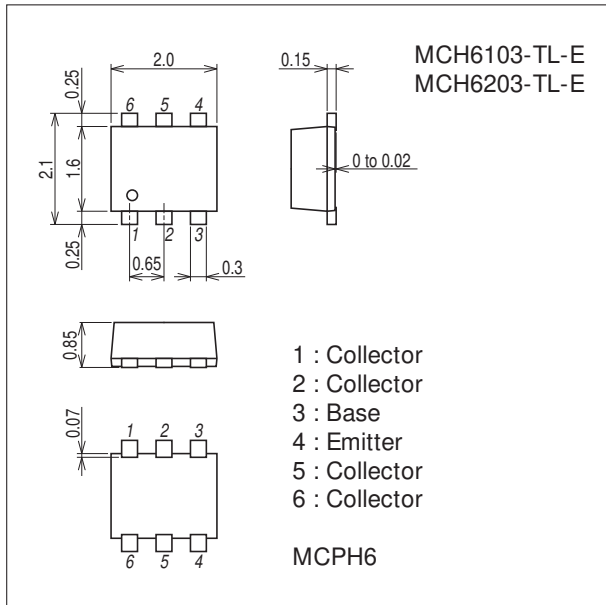
Parameter	Symbol	Conditions	Ratings	Unit
Collector-to-Base Voltage	V_{CBO}		(-) $50/80$	V
Collector-to-Emitter Voltage	V_{CES}		(-) $50/80$	V
	V_{CEO}		(-) 50	V
Emitter-to-Base Voltage	V_{EBO}		(-) 5	V

Continued on next page.

Package Dimensions

unit : mm (typ)

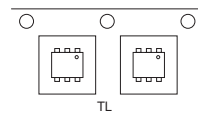
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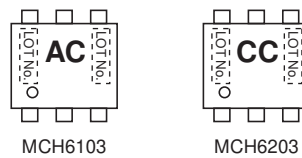
Product & Package Information

- Package : MCPH6
- JEITA, JEDEC : SC-88, SC-70-6, SOT-363
- Minimum Packing Quantity : 3,000 pcs./reel

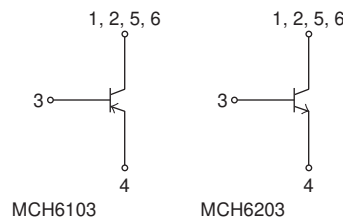
Packing Type: TL



Marking



Electrical Connection



MCH6103/MCH6203

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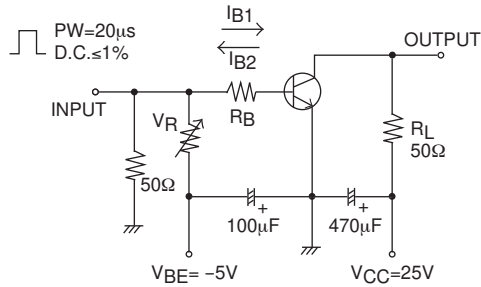
Parameter	Symbol	Conditions	Ratings	Unit
Collector Current	I_C		(-)1.0	A
Collector Current (Pulse)	I_{CP}		(-)3	A
Base Current	I_B		200	mA
Collector Dissipation	P_C	When mounted on ceramic substrate (600mm ² ×0.8mm)	1.0	W
Junction Temperature	T_j		150	°C
Storage Temperature	T_{stg}		-55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Electrical Characteristics at $T_a=25^\circ\text{C}$

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Collector Cutoff Current	I_{CBO}	$V_{CB}=-140\text{V}, I_E=0\text{A}$			(-)0.1	μA
Emitter Cutoff Current	I_{EBO}	$V_{EB}=-14\text{V}, I_C=0\text{A}$			(-)0.1	μA
DC Current Gain	h_{FE}	$V_{CE}=-12\text{V}, I_C=(-)100\text{mA}$	200		560	
Gain-Bandwidth Product	f_T	$V_{CE}=-110\text{V}, I_C=(-)300\text{mA}$		420		MHz
Output Capacitance	C_{ob}	$V_{CB}=-110\text{V}, f=1\text{MHz}$		(9)6		pF
Collector-to-Emitter Saturation Voltage	$V_{CE(sat)1}$	$I_C=(-)500\text{mA}, I_B=(-)10\text{mA}$		(-280)130	(-430)190	mV
	$V_{CE(sat)2}$	$I_C=(-)300\text{mA}, I_B=(-)6\text{mA}$		(-145)90	(-220)135	mV
Base-to-Emitter Saturation Voltage	$V_{BE(sat)}$	$I_C=(-)500\text{mA}, I_B=(-)10\text{mA}$		(-)0.81	(-)1.2	V
Collector-to-Base Breakdown Voltage	$V_{(BR)CBO}$	$I_C=(-)10\mu\text{A}, I_E=0\text{A}$	(-50)80			V
Collector-to-Emitter Breakdown Voltage	$V_{(BR)CES}$	$I_C=(-)100\mu\text{A}, R_{BE}=0\Omega$	(-50)80			V
	$V_{(BR)CEO}$	$I_C=(-)1\text{mA}, R_{BE}=\infty$	(-)50			V
Emitter-to-Base Breakdown Voltage	$V_{(BR)EBO}$	$I_E=(-)10\mu\text{A}, I_C=0\text{A}$	(-)5			V
Turn-On Time	t_{on}	See specified Test Circuit.		(36)38		ns
Storage Time	t_{stg}			(173)332		ns
Fall Time	t_f			(28)40		ns

Switching Time Test Circuit

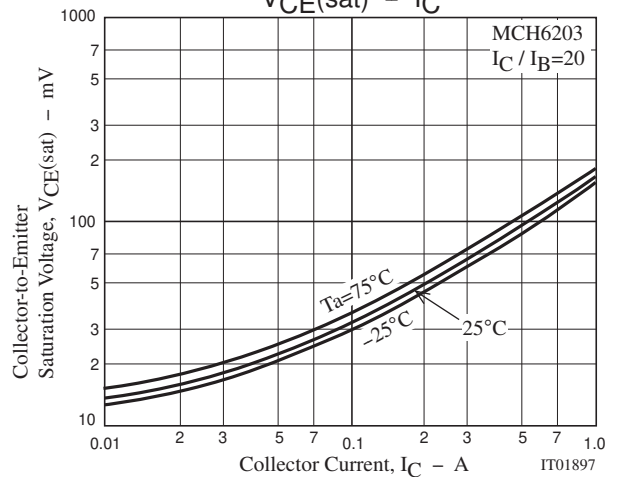
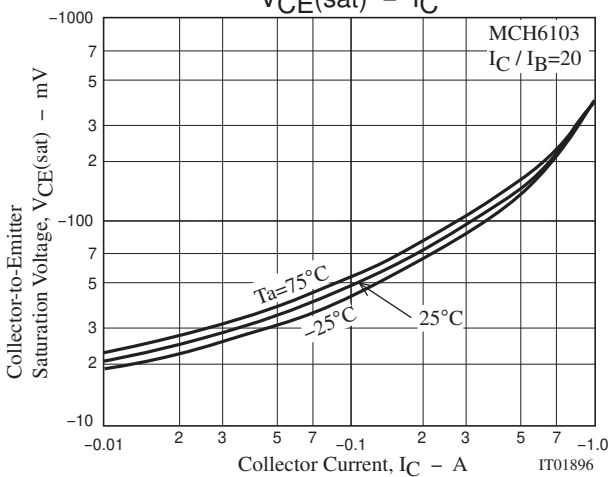
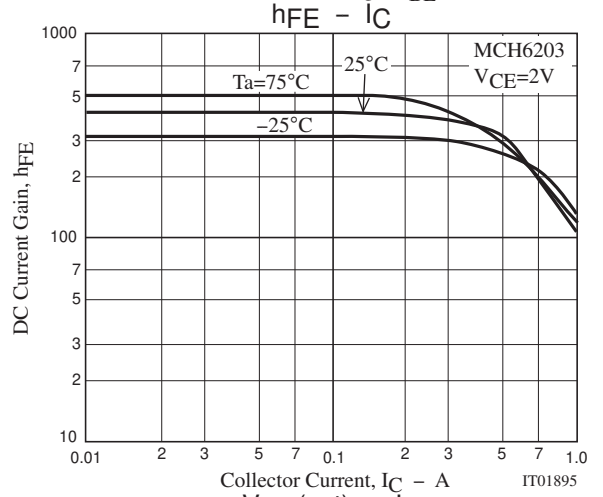
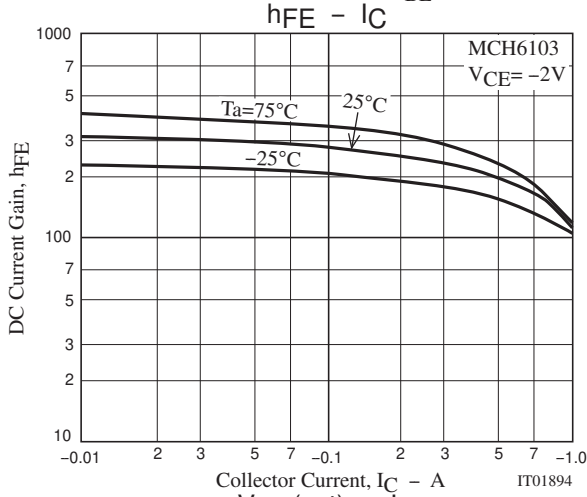
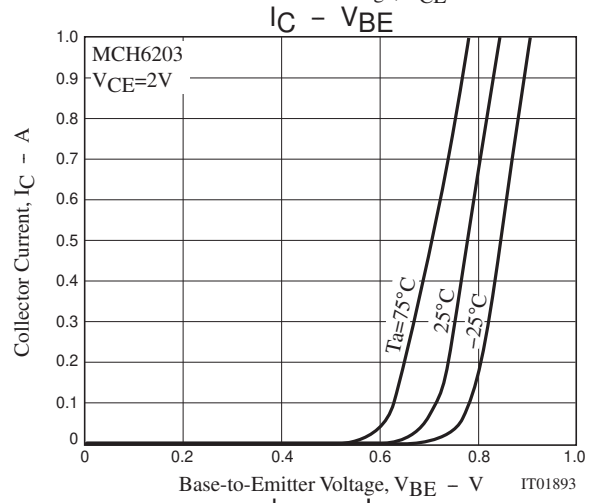
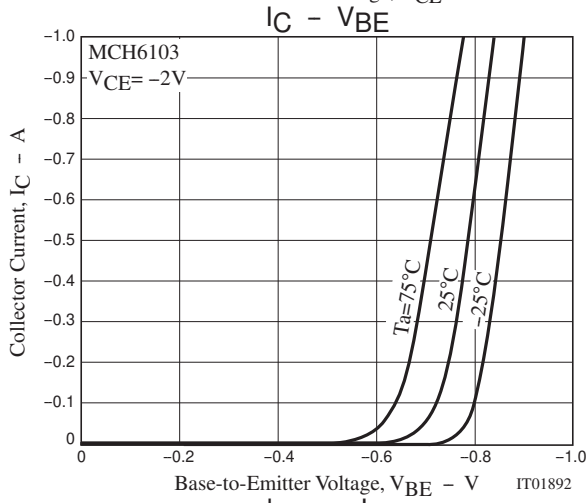
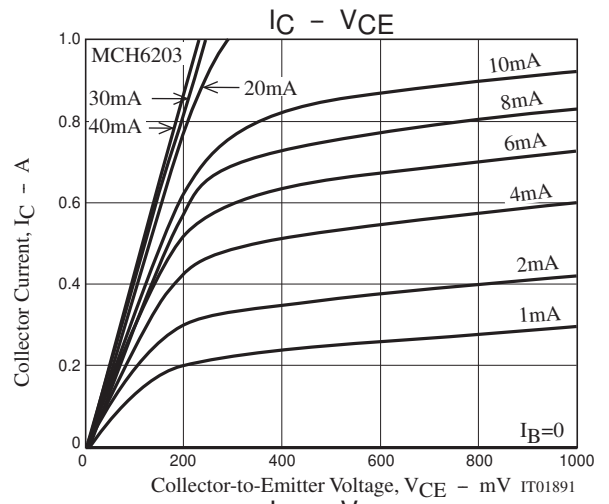
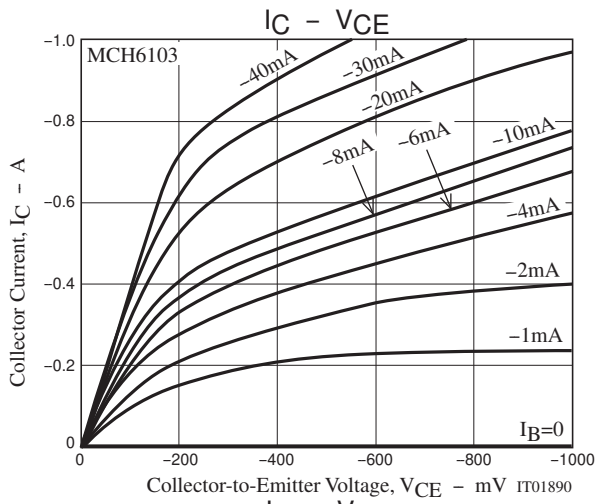


$I_C=20I_{B1} = -20I_{B2}=500\text{mA}$
For PNP, the polarity is reversed.

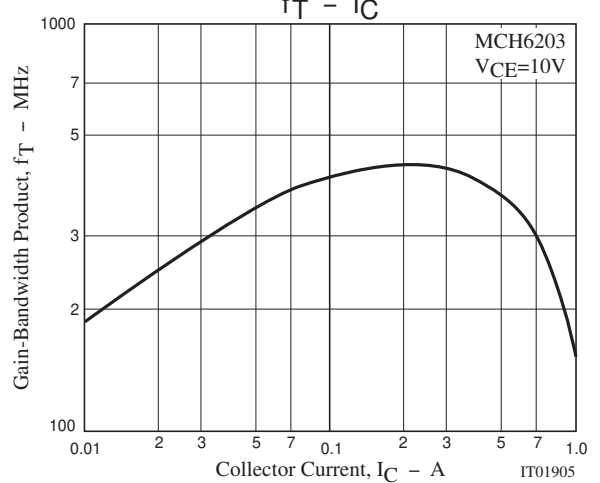
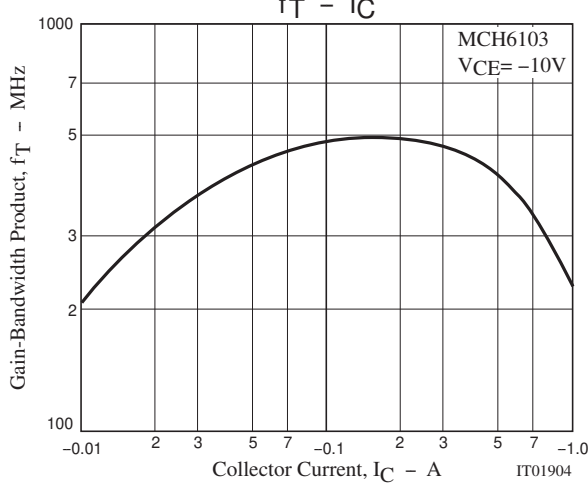
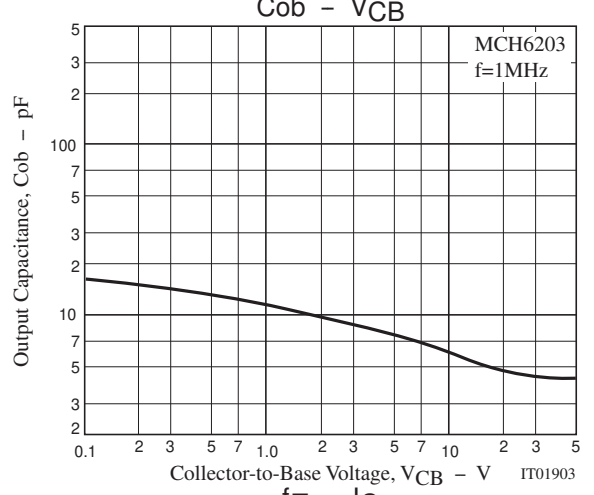
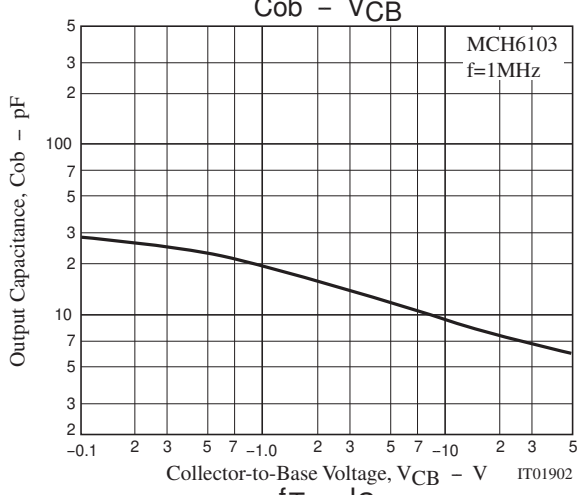
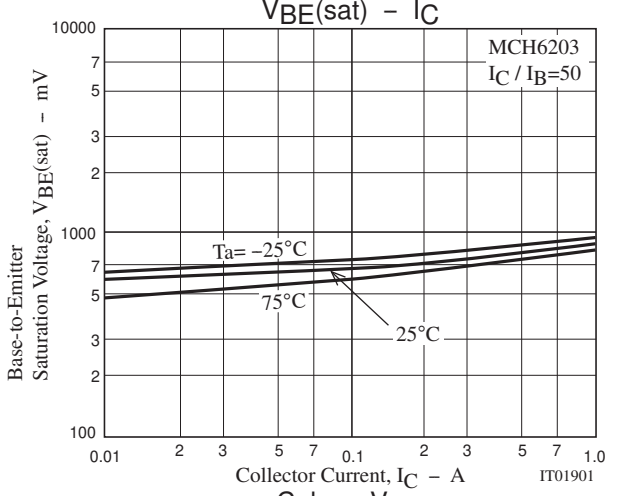
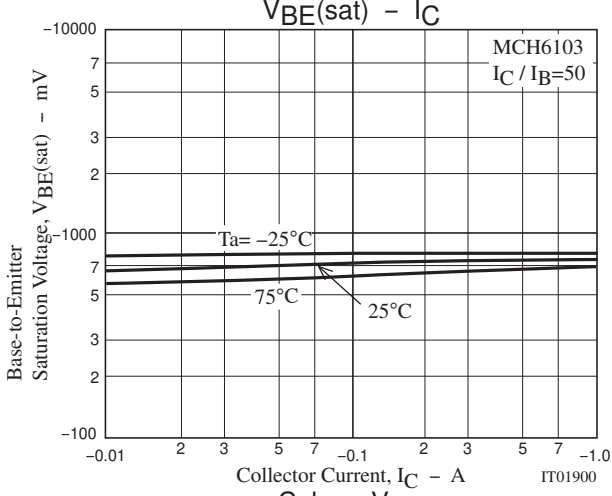
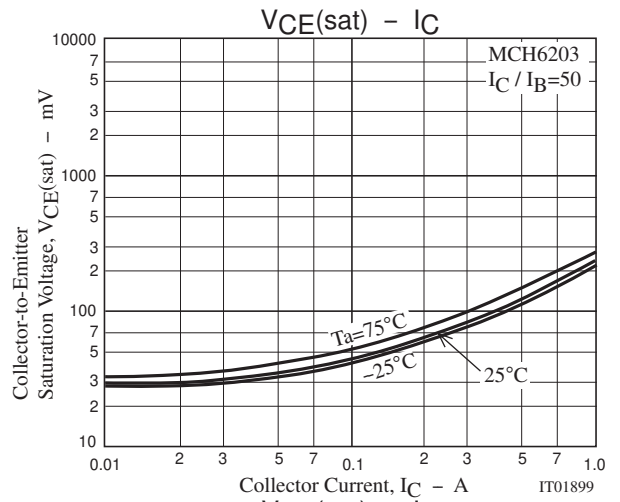
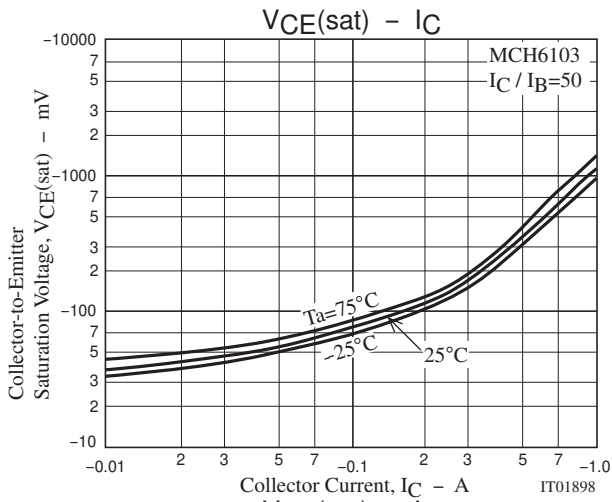
Ordering Information

Device	Package	Shipping	memo
MCH6103-TL-E	MCPH6	3,000pcs./reel	Pb Free
MCH6203-TL-E	MCPH6	3,000pcs./reel	

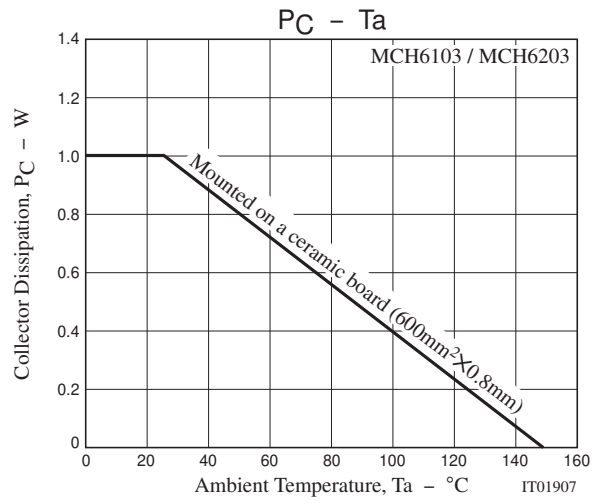
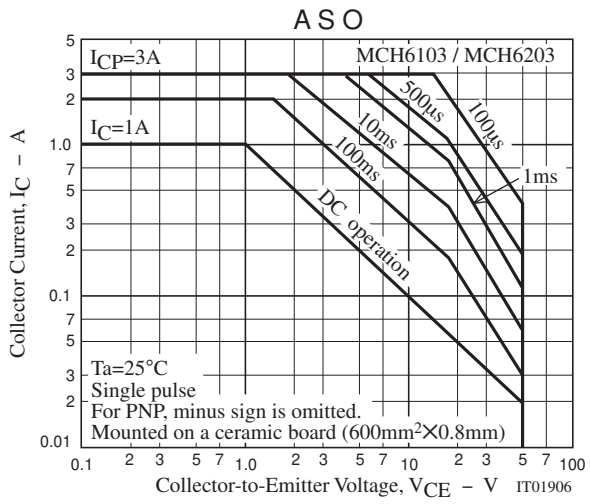
MCH6103/MCH6203



MCH6103/MCH6203



MCH6103/MCH6203



MCH6103/MCH6203

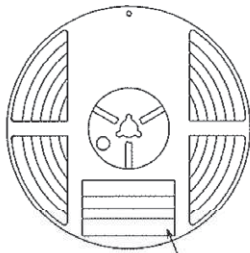
Embossed Taping Specification

MCH6103-TL-E, MCH6203-TL-E

1. Packing Format

Package Name	Carrier Tape Type	Maximum Number of devices contained (pcs)			Packing format	
		Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)
MCPH6	MCP4	3,000	15,000	90,000	5 reels contained Dimensions:mm (external) 183×72×185	6 inner boxes contained Dimensions:mm (external) 440×195×210

Packing method



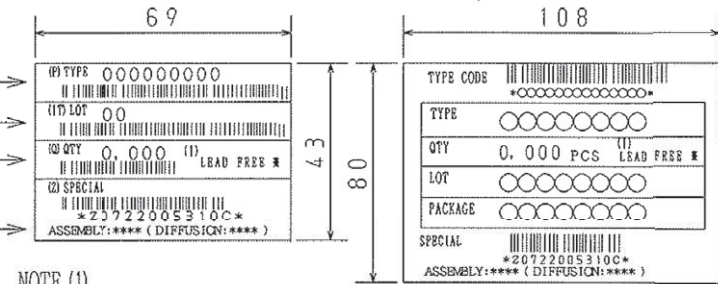
Type No.
LOT No.
Quantity
Origin

Reel label

Reel label, Inner box label
(unit :mm)

Outer box label

It is a label at the time of factory shipments.
The form of a label may change in physical distribution process.



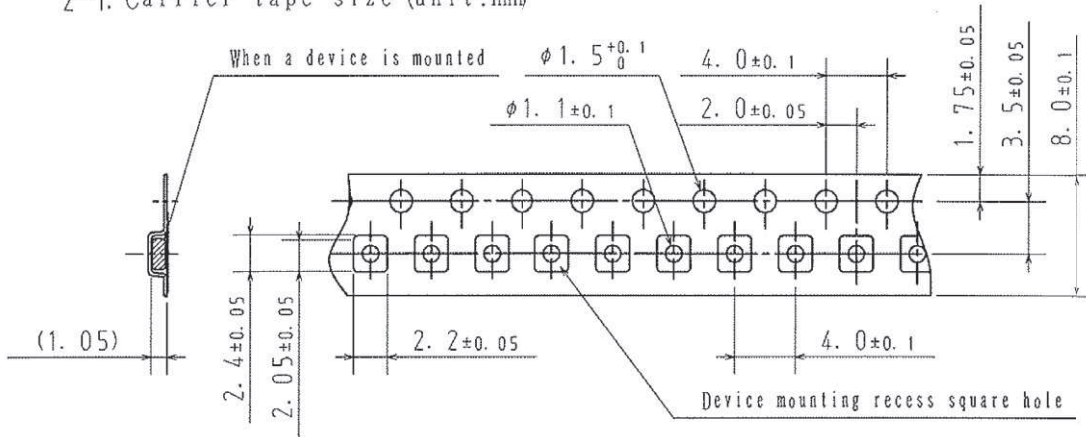
NOTE (1)

The LEAD FREE * description shows that the surface treatment of the terminal is lead free.

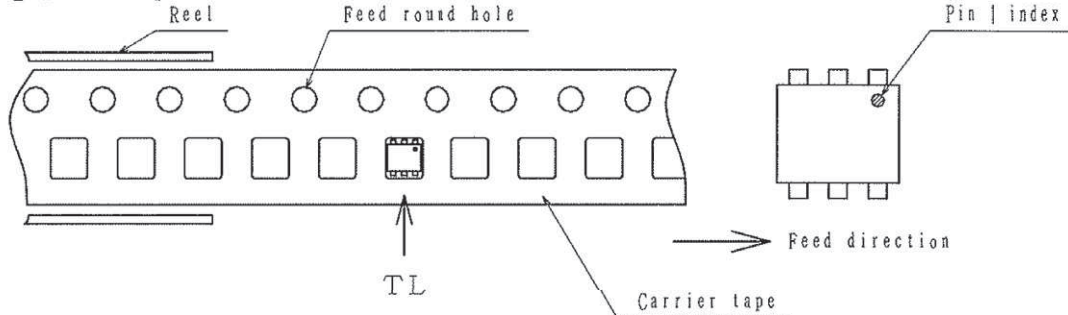
Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3

2. Taping configuration

2-1. Carrier tape size (unit:mm)



2-2. Device placement direction

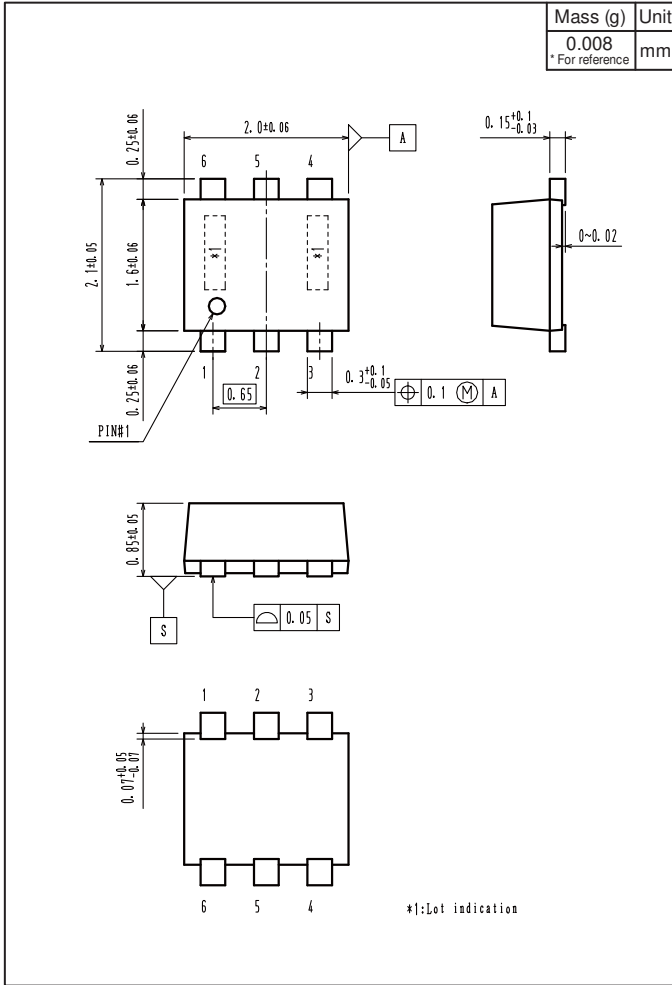


Those with pin | index on the feed hole side.....TL

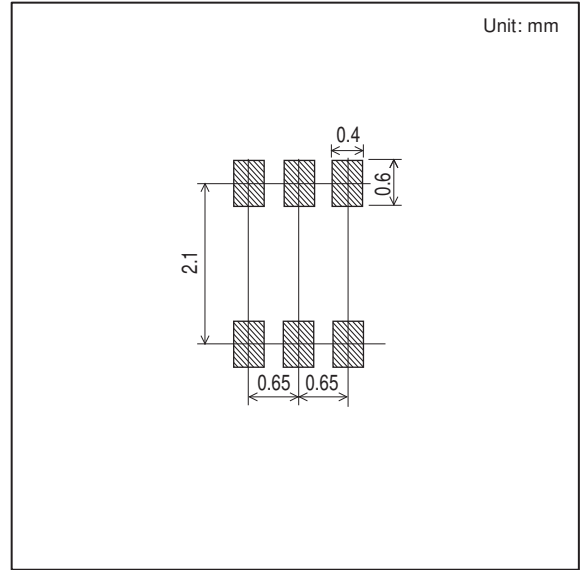
MCH6103/MCH6203

Outline Drawing

MCH6103-TL-E, MCH6203-TL-E



Land Pattern Example



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